### BFR 93 A / BFR 93 A R

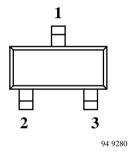
#### Silicon NPN Planar RF Transistor

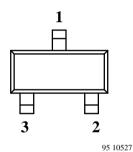
#### **Applications**

Wide band amplifier up to GHz range.

#### **Features**

- High power gain
- High transition frequency
- Low noise figure





BFR93A Marking: R2 Plastic case (SOT 23)

1= Collector; 2= Base; 3= Emitter

BFR93AR Marking: R5 Plastic case (SOT 23R)

1= Collector; 2= Base; 3= Emitter

### **Absolute Maximum Ratings**

Parameters	Symbol	Value	Unit
Collector-base voltage	V <sub>CBO</sub>	20	V
Collector-emitter voltage	V <sub>CEO</sub>	12	V
Emitter-base voltage	V <sub>EBO</sub>	2	V
Collector current	I <sub>C</sub>	50	mA
Total power dissipation $T_{amb} \le 60^{\circ}C$	P <sub>tot</sub>	200	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-65 to +150	°C

#### **Maximum Thermal Resistance**

Parameters	Symbol	Value	Unit
Junction ambient on glass fibre printed board (25 x 20 x 1.5) mm <sup>3</sup> plated with 35 μm Cu	R <sub>thJA</sub>	450	K/W

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#### **Electrical DC Characteristics**

 $T_{amb} = 25^{\circ}C$ 

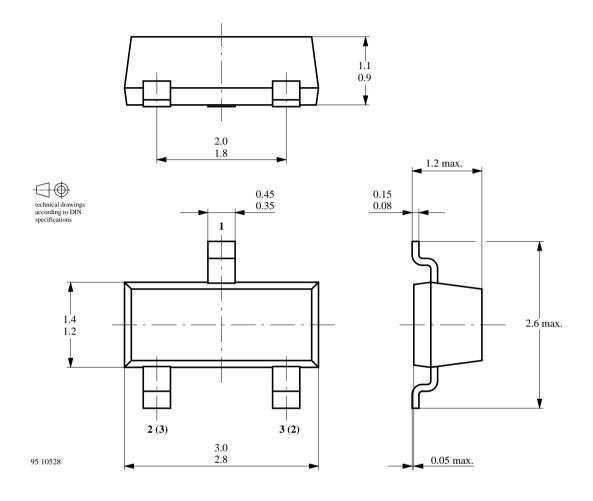
Parameters / Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Collector-base cut-off current $V_{CB} = 10 \text{ V}, I_E = 0 \text{ A}$	I <sub>CBO</sub>			50	nA
Collector-base breakdown voltage $I_C = 10 \ \mu A$	V <sub>(BR)CBO</sub>	20			V
Collector-emitter breakdown voltage $I_C = 2 \text{ mA}, I_B = 0 \text{ A}$	V <sub>(BR)CEO</sub>	12			V
	V <sub>(BR)EBO</sub>	2			V
Collector-emitter saturation voltage $I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$	V <sub>CEsat</sub>		100	400	mV
DC forward current transfer ratio $V_{CE} = 5 \text{ V}, I_C = 30 \text{ mA}$	h <sub>FE</sub>	40	90		

#### **Electrical AC Characteristics**

 $T_{amb} = 25^{\circ}C$ 

Parameters / Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Transition frequency $V_{CE} = 5 \text{ V}, f = 500 \text{ MHz}, I_{C} = 30 \text{ mA}$	$f_{\mathrm{T}}$		6		GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$		0.45		pF
Collector-emitter capacitance $V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$	C <sub>ce</sub>		0.18		pF
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C <sub>eb</sub>		1.5		pF
Noise figure $V_{CE}=8~V,~R_{G}=50~\Omega,~f=800~MHz, \\ I_{C}=5~mA \\ I_{C}=25~mA$	F F		1.6 2.1		dB dB
Power gain $V_{CE}=8 \text{ V, } R_G=50 \Omega\text{, } R_L=R_{Lopt}\text{,} \\ I_C=25 \text{ mA, } f=800 \text{ MHz}$	G <sub>pe</sub>		14		dB
	$v_1 = v_2$		260		mV
Third order intercept point $V_{CE} = 8 \text{ V}, I_C = 25 \text{ mA}, f = 800 \text{ MHz}$	IP <sub>3</sub>		31		dBm

#### **Dimensions in mm**



## **TEMIC**

### BFR 93 A / BFR 93 A R

**TELEFUNKEN Semiconductors** 

#### **Ozone Depleting Substances Policy Statement**

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

#### We reserve the right to make changes without further notice to improve technical design.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by customer. Should Buyer use TEMIC products for any unintended or unauthorized application, Buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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